

# isc N-Channel Mosfet Transistor

# **BUZ202**

#### FEATURES

- Static Drain-Source On-Resistance
  - :  $R_{DS(on)} = 0.5 \Omega (Max)$
- SOA is Power Dissipation Limited
- · High input impedance
- High speed switching
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

### DESCRITION



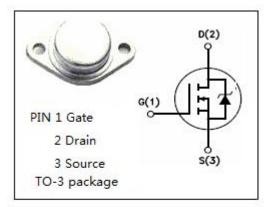
Designed for applications such as switching regulators, switching converters, motor drivers, relay drivers and drivers for high power bipolar switching transistors requiring high speed and low gate drive power.

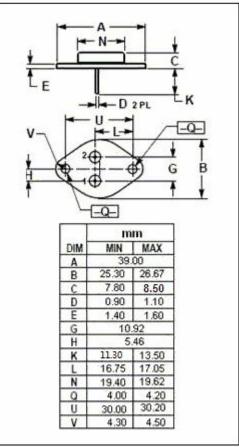
## • ABSOLUTE MAXIMUM RATINGS(Ta=25°C)

SYMBOL	ARAMETER	VALUE	UNIT	
V <sub>DSS</sub>	Drain-Source Voltage (V <sub>GS</sub> =0)	400	V	
V <sub>GS</sub>	Gate-Source Voltage	±20	V	
I <sub>D</sub>	Drain Current-continuous@ TC=25℃	11.5	Α	
I <sub>DM</sub>	Drain Current-Single Plused	46	Α	
P <sub>tot</sub>	Total Dissipation@TC=25°C	125	W	
T <sub>j</sub>	Max. Operating Junction Temperature	150	$^{\circ}$	
T <sub>stg</sub>	Storage Temperature Range	-55~150	$^{\circ}$	

### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
R <sub>th j-c</sub>	Thermal Resistance,Junction to Case	1	°C/W
R <sub>th j-a</sub>	R <sub>th j-a</sub> Thermal Resistance,Junction to Ambient		°C/W







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### **ELECTRICAL CHARACTERISTICS**

T<sub>c</sub>=25℃ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYPE	MAX	UNIT
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0; I <sub>D</sub> =0.25mA	400			V
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> ; I <sub>D</sub> =1mA	2.1		4.0	V
V <sub>SD</sub>	Diode Forward On-voltage	I <sub>S</sub> = 23A ;V <sub>GS</sub> = 0			1.9	V
R <sub>DS(on)</sub>	Drain-Source On-Resistance	V <sub>GS</sub> = 10V; I <sub>D</sub> = 8A			0.5	Ω
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> = ±20V;V <sub>DS</sub> = 0			±100	nA
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =400V; V <sub>GS</sub> = 0			250	μA
Gfs	Forward Transconductance	V <sub>DS</sub> = 25V; I <sub>D</sub> =8A	3.3			S
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> =10V;			75	
tr	Rise Time	I <sub>D</sub> =2.9A;			120	
t <sub>d(off)</sub>	Turn-off Delay Time	$V_{DD}$ =30V; $R_{GS}$ =50 $\Omega$			430	ns
t <sub>f</sub>	Fall Time				140	

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